

EMI and Equipment Malfunction in Cleanroom Environment

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Why Control of EMI is Important on Your Production Floor?

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- ⊗ EMI causes equipment lock-up
- ⊗ EMI causes equipment and sensor malfunction
- ⊗ EMI may cause component damage
- ⊗ EMI is extremely difficult to diagnose using conventional methods

All of the above causes losses and downtime that nobody can afford today



What is EMI?

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- ❁ **ElectroMagnetic Interference** is negative influence of electromagnetic emission on equipment
- ❁ Until equipment is affected by electromagnetic emission in any way, that emission is not EMI, no matter how strong it is
- ❁ A very weak emission can be EMI and a very strong one may be not

EMI-Caused Equipment Failures

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Three Basic Types of Failures

- ⦿ Fatal failure due to overstress
 - direct ESD discharge
 - very high EMI-induced signals
- ⦿ Latch-Up
 - induced voltages are outside of supply rails
 - often recoverable after power-cycling
 - sometimes causes overheating and failure
- ⦿ Injection of false signals
 - Induced signal is comparable to legitimate signals

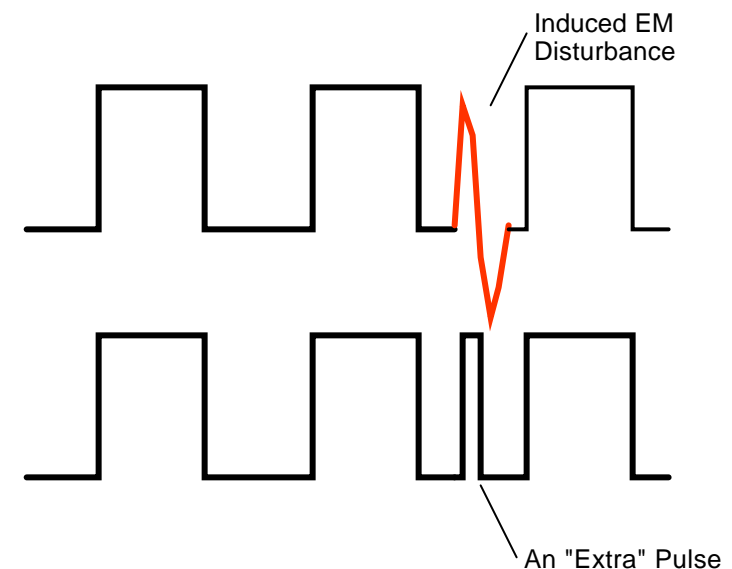
GOLDENEYE



Equipment Lock-Up: False Signals

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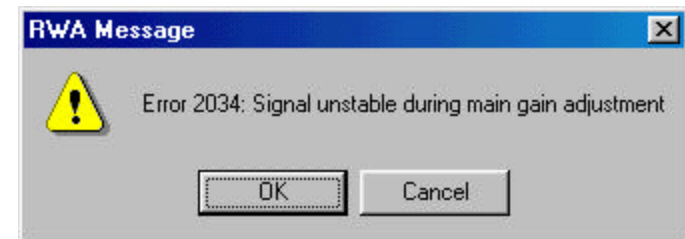
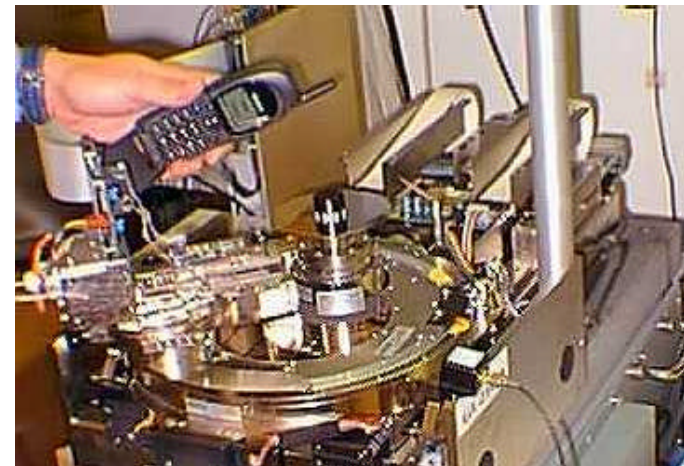
- Electromagnetic fields induce seemingly legitimate signals into electronics circuits which leads to circuit malfunction
- Often, the electronics circuit does not suspect that it was affected by EMI
- Today's high-speed circuits are much more susceptible to ESD-induced high-speed transients
- Virtually impossible to reproduce – difficult to diagnose



Sensor Malfunction

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- ❁ Strong electromagnetic fields induce voltages and currents in circuits
- ❁ In sensors such signals can affect legitimate signals and cause false readings
- ❁ Consequences:
 - disrupted process
 - good components failed
 - bad components passed



TDMA mobile phone caused false readings in sensor of magnetic head tester and finally caused error message after failing several good

GMR heads



ESD-Caused EMI

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- ⦿ ESD Event is rapid current surge:
causes magnetic field
- ⦿ ESD Event is rapid drop of voltage:
causes electric field
- ⦿ In the far field: electromagnetic field
- ⦿ ESD Events cause strong ground and power line
currents -- EMI via conductive path
- ⦿ ESD-induced EM fields have broad spectrum, high
energy and rapid rise time -- good candidates for EMI



EMI: The Path to Destruction

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- ⦿ Charge is created
- ⦿ Charge results in ESD Event
- ⦿ ESD Event causes strong electromagnetic emission
- ⦿ This emission propagates across the cleanroom and reaches the “victim”
- ⦿ Equipment malfunction



Propagation of Electromagnetic Emission

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☼ Radiated

- Electromagnetic field composed of electric and magnetic fields propagates via air path just as emission from a mobile phone would reach the base station
- This field would create voltages and currents in any metal object, i.e. wire, PCB trace, etc.

☼ Conducted

- The most neglected type of propagation
- High-frequency currents move via power, ground and data cables and inject undesirable signals into equipment

☼ Mixed

- Radiated emission generates signals in wires and cables. These signals are then injected into equipment via conductive path



How Equipment Receives Electromagnetic Waves

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- ⦿ Any piece of wire is an antenna
- ⦿ Any antenna will convert electromagnetic field into voltage and/or current
- ⦿ A signal wire, a data cable, a ground wire, a power cable, a trace on the circuit board -- they are all antennae
- ⦿ In order for antenna to be efficient, it needs to be 1/4 of the wavelength of the electromagnetic field
- ⦿ With the rise time of ESD Events of 1nS or less, the energy spectrum of the rising front lies in the range of 500MHz to 2GHz or even higher
- ⦿ At these frequencies the efficient antenna would be 1.5" to 6" long
- ⦿ This covers most of the traces on the circuit boards



Charge in FABs

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☼ Wafers

- Wafers get charged by handling
- 300mm wafer can carry plenty of charge
- Wafers are insulators that cannot be discharged by grounding
- Wafers cannot be discharged by ionization while in pods due to lack of air flow
- Highly-charged wafers induce charge on metal surfaces

☼ Anything Moving

- Carts
- Insulated rollers

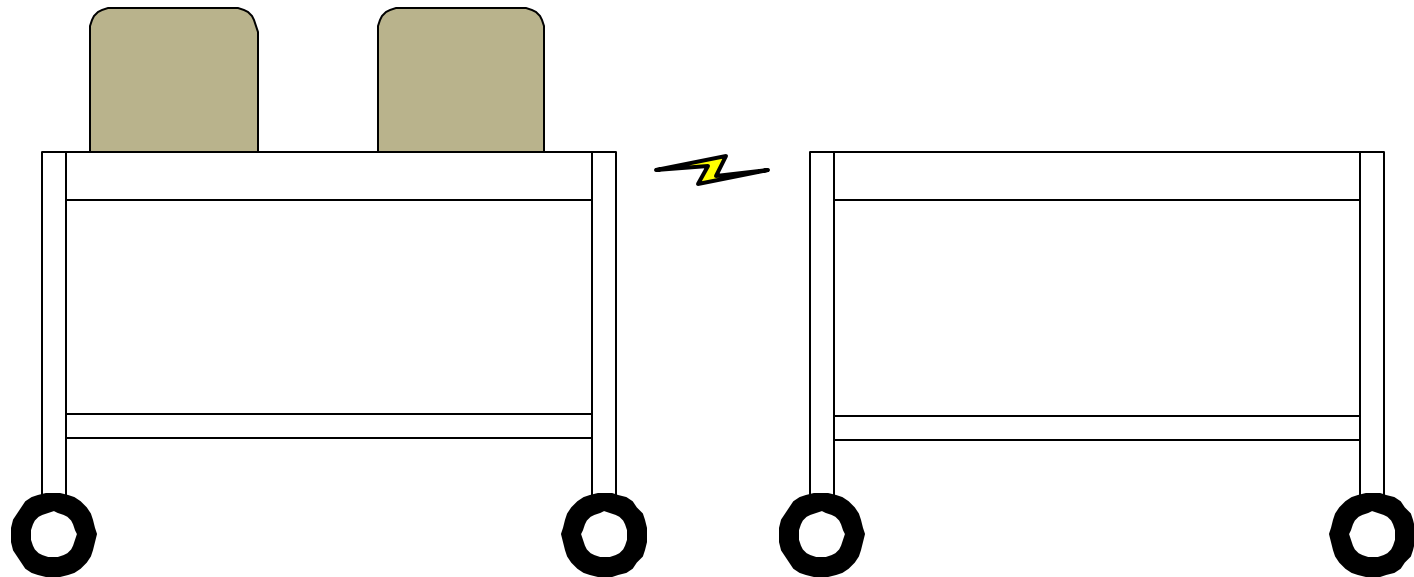
☼ Other

- Improperly installed or out of balance ionizers

Isolated Metal Carts: Armed Bombs

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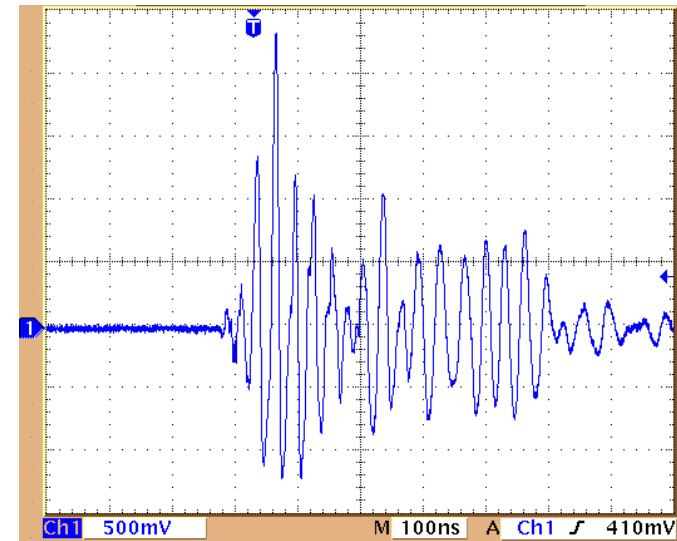
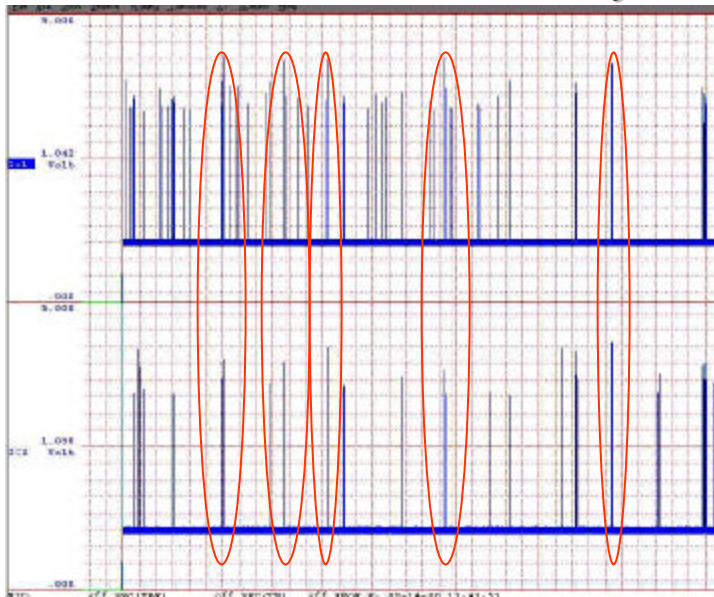
- ⦿ Wafers are charged to the limit
- ⦿ SMIF pods with wafers are placed on steel cart
- ⦿ Cart is charged by the wafers via inductance
- ⦿ Wheels are insulators



EMI Environment Inside the Tool

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- ❁ Extraneous EMI Events are out of sync with the operation of equipment
- ❁ EMI Events from the carts was extremely strong even from far away





Induced Charge Issues

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- ⦿ The most harmful ESD Events are metal-to-metal
- ⦿ Highly-charged wafers in pods induce charge on metal objects
- ⦿ Metal-to-metal contact releases high levels of EMI energy that propagates across the fab causing equipment malfunction
- ⦿ Large-mass metal object do not have to be charged to very high voltage to generate high energy EMI
- ⦿ It is next to impossible to discharge wafers in pods in a normal production process
- ⦿ What can be done:
 - Dissipate induced charges on metal objects
 - Prevent metal-to-metal contact

Grounding from EMI Point of View

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- Traditionally, ground quality is measured with a multimeter at DC or at very low frequencies
- At high frequencies this method is useless
- It is mostly high-frequency signals that cause equipment malfunction



Mochi Moqui sacred shaman stones balls for “energy grounding” (Navaho Tribe)

Electrical Circuits Behavior at Low and at High Frequencies

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Examples:

Capacitor

Long Wire



Low frequencies and DC:

Open circuit
(infinite resistance)

Short circuit
(low resistance)



High frequencies (MHz and GHz):

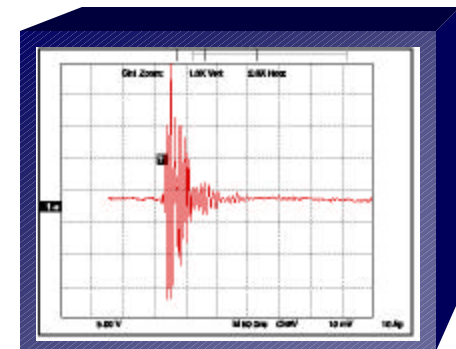
Short circuit
(low impedance)

Open circuit
(high impedance)

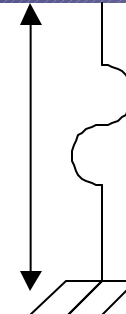
Grounding at Low and High Frequencies

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- ⊗ If ground is done improperly, a ground wire acts as an inductor with high impedance at EMI frequencies
- ⊗ High-frequency “junk” doesn’t dissipate into the ground and resides on a workbench or on a tool
- ⊗ Conventional methodology and tools provide false assurance of “good ground”



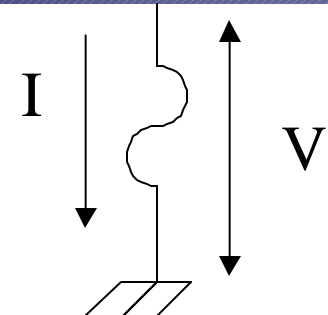
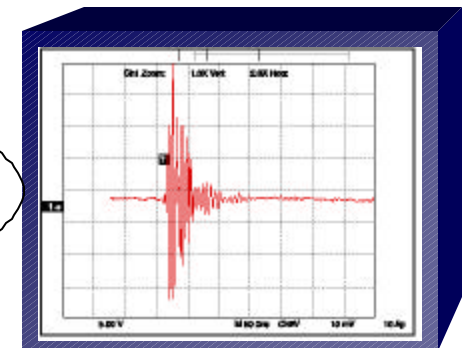
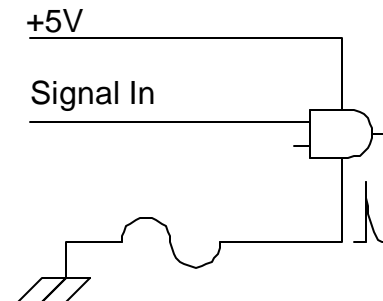
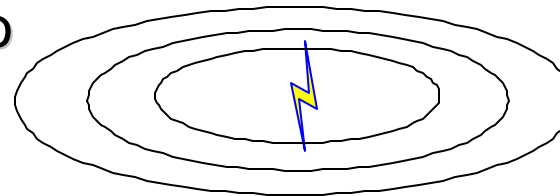
0 Ohms for DC
Open circuit for EMI



Equipment Lock-Up: Ground Bounce

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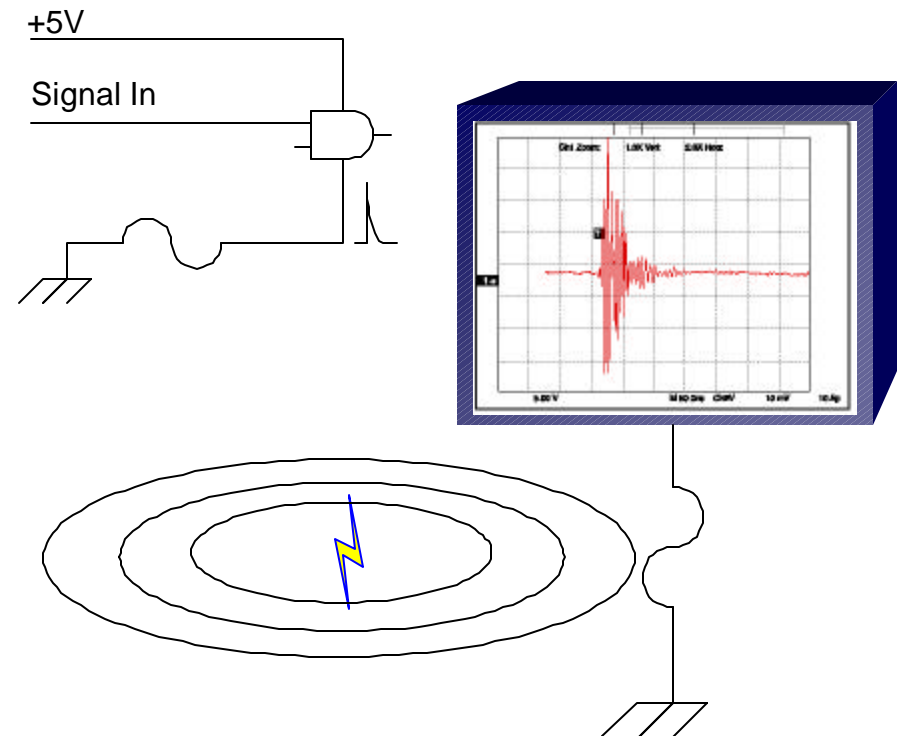
- EMI induces voltages in equipment's ground
- Current flows from equipment's ground to facility's ground
- If ground path is imperfect, voltage drop develops
- Equipment ground "bounces"
- Circuit signal levels are no longer valid
- Equipment malfunctions



Equipment Lock-Up: Injection of EMI into Ground Wires

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- EMI induces voltages in long and poorly-done ground wires
- Equipment ground “bounces”
- Circuit signal levels are no longer valid
- Equipment malfunctions



Checking for Good Ground

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- Good ground is an “infinite sink.” It should have NO voltage on it. Just like a multimeter or a static field voltmeter shouldn’t see any DC voltage on a good ground, there should be no high-frequency voltages as well



- Voltage causes electric field. High-frequency EMI can be easily measured.
- Bring EMI meter (not static field meter!) close to the grounded surface of your equipment or a workbench. Measure peak signals (very important for ESD-caused transients)
- If the equipment or the workbench is well-grounded, the emission level will drop
- OK ground will cause emission level to raise slightly
- Poor ground will cause emission level to raise several times



Things to Do to Improve Your Ground

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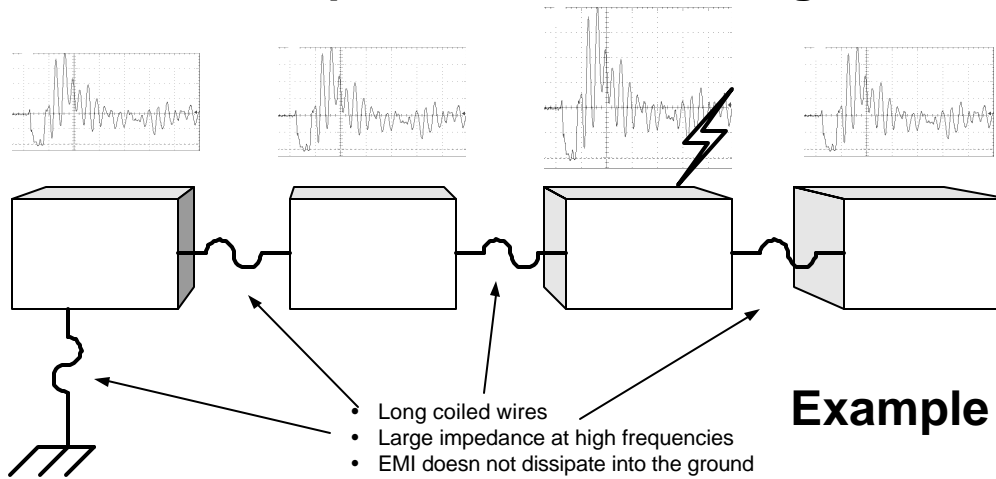
• Don't Panic

- Shorten your ground wires
- Straighten your ground wires
- Use large gauge braided cable
- Connect it to **known good** ground
- Do not chain-link many workstations
- Always verify ground quality for EMI
- Do it on a regular basis

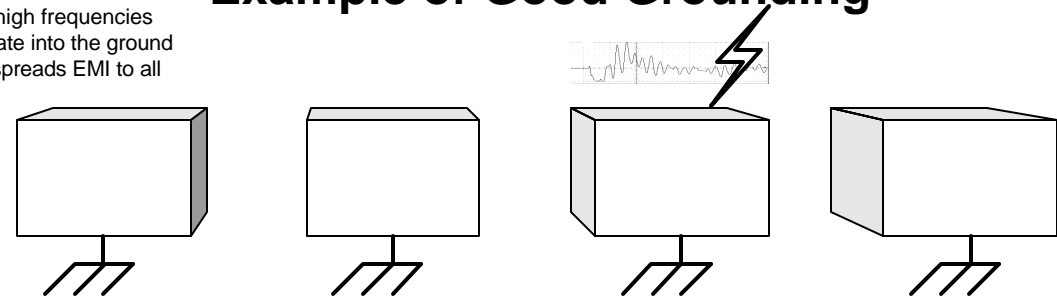
Do Not Use Long Ground Links

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Example of Poor Grounding



Example of Good Grounding



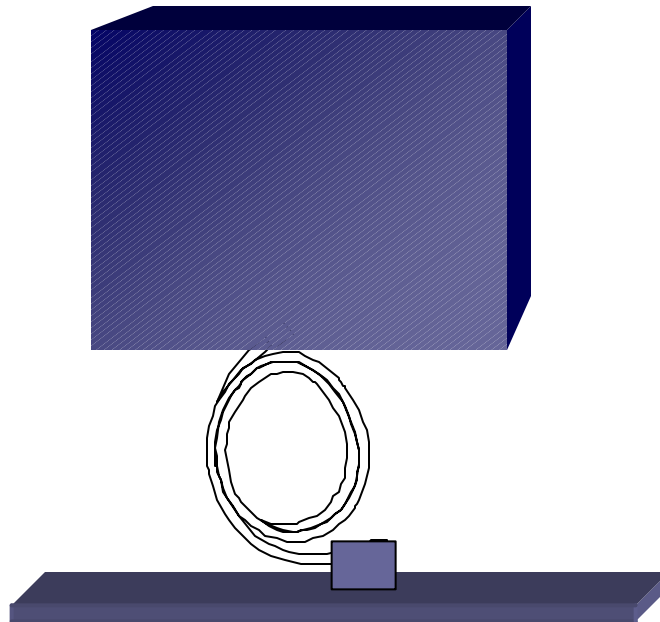
- Short straight wires
- Low impedance at high frequencies
- Most of EMI dissipates into the ground
- Individual grounding prevents spreading of EMI to devices in the chain

Short Straight Ground Wires Reduce Effects of EMI

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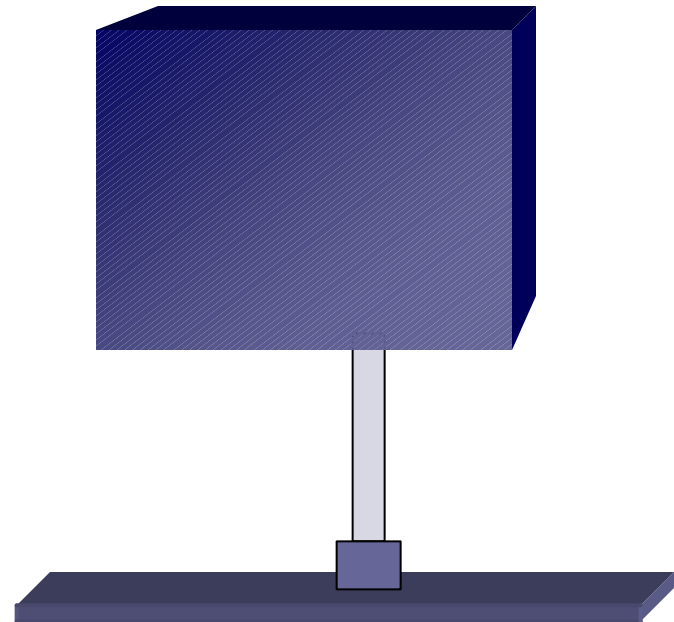
Bad for EMI

Long coiled solid wire



Good for EMI

Short straight stranded cable





How to Minimize Effect of EMI on Operation of a FAB -- 1

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| | |
|---------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|
| Reduce charge | Proper choice of materials Reduce contact between dissimilar materials Provide static-dissipative path Provide ionization wherever appropriate |
| Avoid discharges | Avoid metal-to-metal contacts Provide for slow dissipation rather than discharges |
| Reduce propagation of EMI | Improve and maintain EMI-valid ground throughout the facility Use EMI filters on power and data lines |



How to Minimize Effect of EMI on Operation of a FAB -- 2

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| | |
|---------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| EMI-harden your equipment | Make sure that equipment you install in your facility was tested for EMI susceptibility (IEC 1000-4-2, IEC 1000-4-3 and IEC 1000-4-4) Apply proper grounding techniques Decouple long data cables Implement ferrite chokes on cables (not ground!) |
| Know your EMI environment | Monitor EMI environment Do EMI audit Have EMI specification (max. levels) Keep record of EMI environmental data for correlation of failures |



EMI: Verification Approach

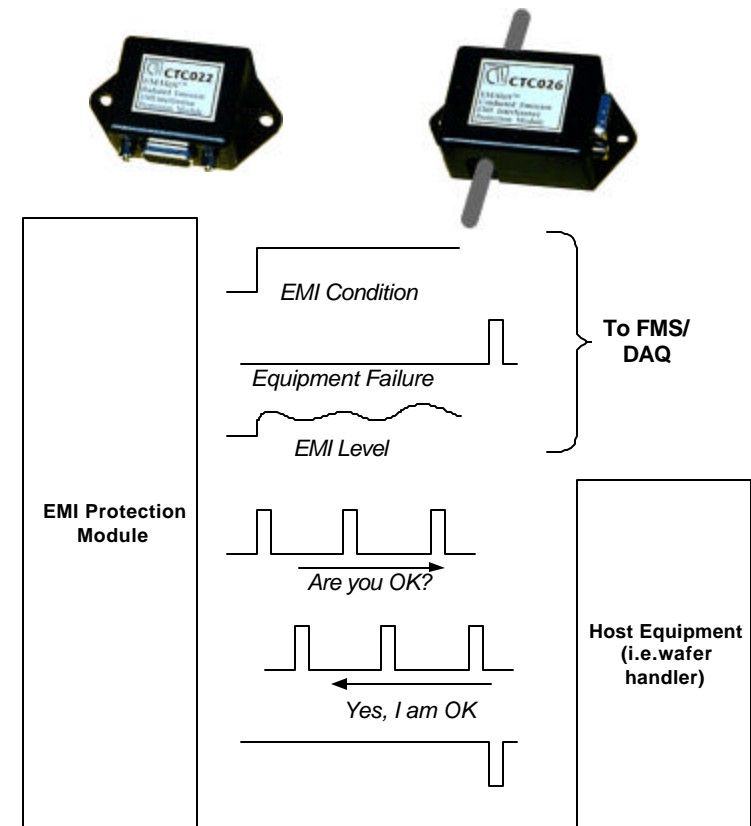
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- EMI is continuously monitored at the most vulnerable area of a tool
- If EMI is detected, the tool is instructed not to do anything new
- If EMI is detected, its presence is datalogged for future analysis
- If EMI is detected, alarm is issued
- If EMI is detected, tool can be checked

The Last Line of Defense: EMI Protection Devices

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- When strong EMI is present, EMAlert issues a signal indicating strong EMI conditions
- Based on that, equipment can be set to idle until the EMI condition goes away
- A remote warning of EMI condition is possible
- It is possible to test lock-up condition of equipment and even reset it
- EMI environment can be datalogged for failure correlation and improvement verification



EMI Protection Devices -- the last line of defense against EMI

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• Case Study

- A lumber company in Canada was using metal detectors in their saw mill operation in order to find nails in logs so that the saw blade is not damaged
- Workers are using walkie-talkies that caused malfunction of the metal detector
- EMAIert® CTC022 installed next to the metal detector stops log advancement when the EMI is above the set threshold





EMI Monitoring -- Hidden Problems Revealed

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- ⦿ Don't let your equipment failures due to ESD and EMI catch you by surprise
- ⦿ Know the real cause of failure (whether it is ESD/EMI related or not) -- no need to guess
- ⦿ Real-time response to EMI/ESD condition is possible
- ⦿ Address the root cause of the problem and prevent it from happening again.



Why EMI Matters Now More than Ever?

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- ⦿ Smaller geometries of today's devices make them much more susceptible to ESD and EMI
- ⦿ The new circuits work at higher speeds and now "notice" the ultra-short spikes that older slower circuits ignored
- ⦿ Higher frequencies used in today's electronics create more emission due to better antenna factor
- ⦿ Today's circuits work at lower voltages: as low as 1.8V. Much lower levels of EMI are needed for their disturbance.
- ⦿ **The trend doesn't look promising.**



Contact Information

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